

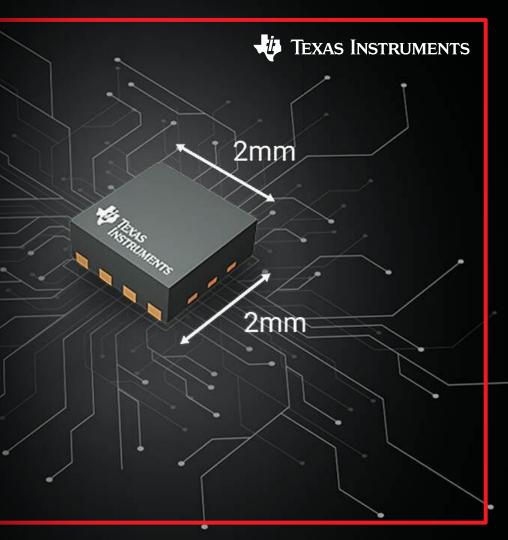
The smallest package TI
MSPM0 MCU enables room to
do more in your design

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**MSP Product Marketing Engineer** 

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**MSP** Applications Engineer



## **Agenda**

- TI's ARM Cortex-M0+ MCU portfolio overview
- MSPM0C Subsystem Designs
- Example applications with MSPM0C MCUs
- Getting started with MSPM0C MCUs

## MSPM0 MCUs | reducing your system cost

## Cost optimization

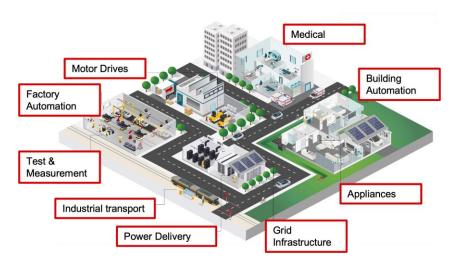
Smallest packages

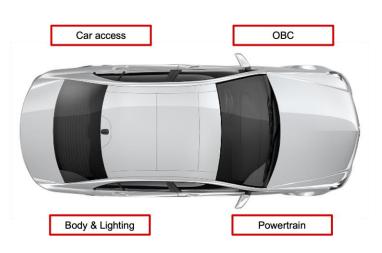
Advanced analog integration

Best cost structure for microcontrollers with mix of digital, analog & memory

Leverage the cost benefit of packages that are used by high volume analog

Save components, board space and simplify supply chain with integrated advanced analog





Pick a device optimized for your solution from a broad, pin-2-pin portfolio



## MSPM0 MCUs | scalable portfolio

Up to 125C Ta 1.62-3.6V



- 80MHz CPU
- CAN-FD options
- Fast 4Msps sim-sam ADCs
- · Math accelerator

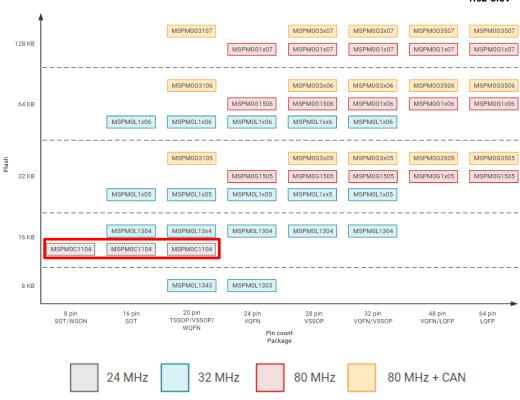


- 32MHz CPU
- 71µA/MHz (CoreMark run)
- 6µA-max standby at 85 °C
- 1µA-typ standby at 25 °C

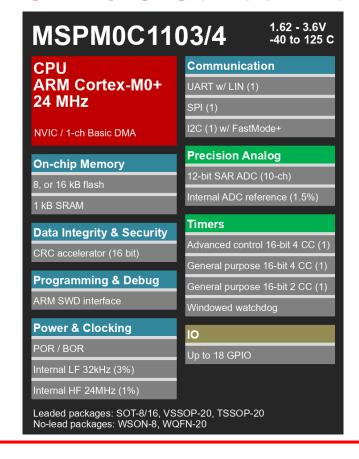


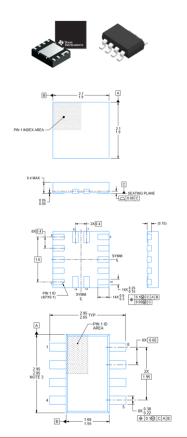
- 24MHz CPU
- Smallest QFN package (2x2)
- 0.5/0.65mm pitch packages
- · Pin-compatible with industry

Unified software development kit & tools Pin-to-pin compatible in 10+ packages TI 65nm flash multi-sourced manufacturing



## **MSPM0 C-Series microcontrollers**





< \$0.18 starting at 1 kU

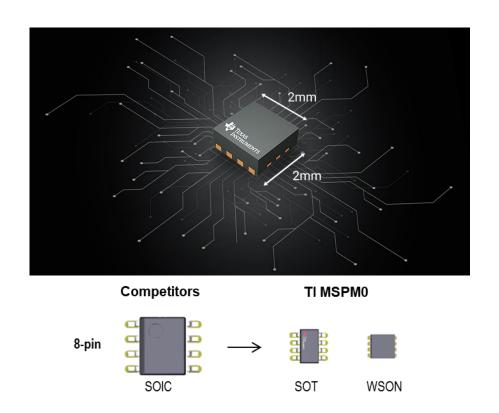
10

8-kB – 16-kB memory, package, peripheral options

6

of the industry's smallest, easiest to assemble MCU Packages

## **MSPM0C MCUs** | Room to do more



## 6 GPIOs

available with 8-pin WSON-DGS package

2x2 mm<sup>2</sup>
Tl's smallest M0+ MCU package

7.35x Smaller compared to common 8-pin SOIC

## MSPM0 software and tools ecosystem

Rapidly develop with low-cost MSPM0 microcontrollers



## MSPM0 SDK

Software, tools, and documentation to accelerate product development



## **MSPM0** LaunchPad

An unconstrained prototyping platform

LP-MSPM0C1104 LaunchPads as low as \$5.99



## SysConfig & Analog Configurator

Intuitive graphical configuration and code generation



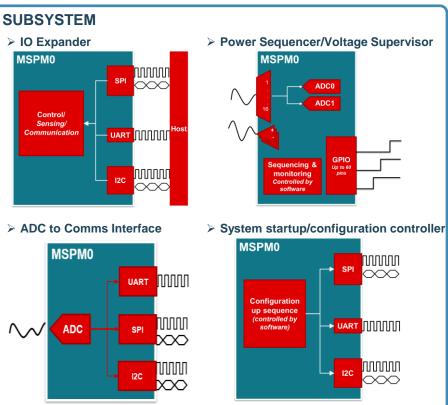
## TI MSPM0 Subsystems

Subsystem design and software examples for common use-cases

## MSPM0 C-Series MCUs | Broad applications

24 MHz low-cost MCU with up to 16kB flash, 20 pins, 12-bit ADC





# **Subsystem Designs**with MSPM0C MCUs

**Dennis Lehman** 

MSP Applications Engineer



## Low cost ADC to SPI, I2C, UART

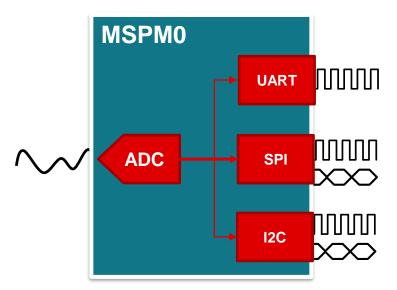
## **Using low cost MSPM0 MCUs**

#### **Functions**

- Samples analog signals with ADC
- Sends ADC result through desired communication interface (SPI, I2C, UART)

#### **Advantages**

- Reduce size of your PCB by using the MSPM0's internal ADC and send through SPI, I2C and/or UART.
- Can pre-process the ADC data before sending to another device.
- Can send through any included communication interface for flexibility



#### **Key questions**

- Does your system need an analog signal read?
- Does your system require SPI, I2C, or UART communication?
- Do you have limited PCB space?

- SDK
  - ADC to UART
  - ADC to I2C
  - ADC to SPI
- Devices
  - MSPM0G
  - MSPM0L
  - MSPM0C

## **I2C IO Expander**

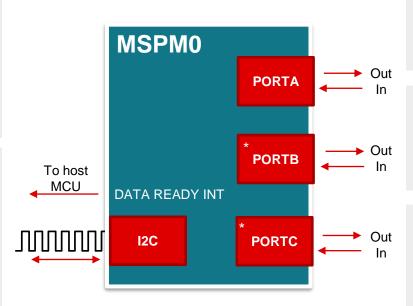
## **Using low cost MSPM0 MCUs**

#### **Functions**

- GPIO Output Pin addressable Set, Clear and Toggle
- GPIO Input up to 32-bits
- · Data ready interrupt to host MCU
- External input interrupts

#### **Advantages**

- Extend host MCU GPIO functionality
- Effortless configuration using Sysconfig
- Supports any combination of IO pin configurations
- Leverage MSPM0 IO pin features
- · Simple protocol



## **Key questions**

- · Does your system need more GPIO?
- Present MCU not scalable?

#### **Key technicals**

- 12C FM (400kHz), FM+ (1 Mbit/s)
- Number of available IO Ports is device dependent
- · Low power operation

- Devices
  - MSPM0G
  - MSPM0L
  - MSPM0C



## Power sequencer and voltage supervisor

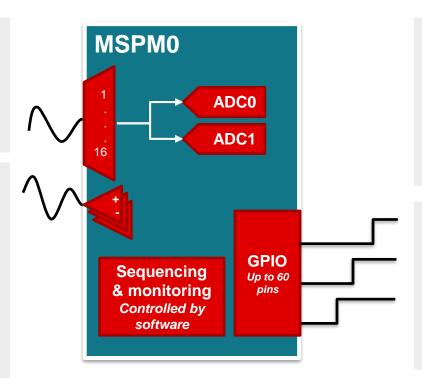
## Using low cost MSPM0 MCUs

#### **Functions**

- Sequences power enables to correctly start system from power down.
- Acts as voltage supervisor to ensure proper system operation

#### **Advantages**

- 200us cold boot time gets system started quickly
- Precise, cycle-by-cycle control of GPIO timing
- Up to 16 ADC input channels for voltage monitoring
- 3x comparators for high speed fault detection and reaction



### **Key questions**

- Does your system require power rail coordination?
- Does your system require voltage supervision?
- Is your system using a dedicated power rail sequencing device?

- SDK
  - Power Sequencing
- Devices
  - MSPM0G
  - MSPM0L
  - MSPM0C



## System startup/configuration controller

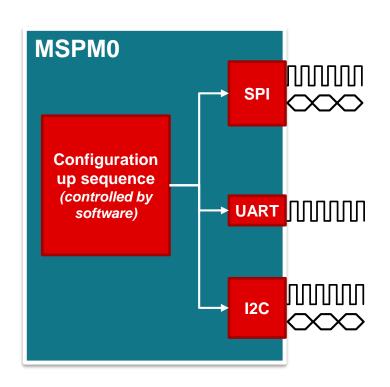
## Using low cost MSPM0 MCUs

#### **Functions**

 MCU will do startup configuration of system via I2C, UART, and/or SPI

#### **Advantages**

- 200us cold boot time gets system started quickly
- Fast data rates, multiple instances minimize system boot up time
  - · 2x SPI up to 32MHz
  - 4x UART up to 10MHz
  - 2x I2C Fast-mode plus (1MHz)
- After configuration is finished MCU can perform other system tasks, or
- MCU can enter SHUTDOWN mode (50nA) to reduce system power.



### **Key questions**

- Does your system have a complex start up sequence?
- Does your system need to perform any initialization tasks on power up
- Does your system use a start/configuration FPGA?

- Devices
  - MSPM0G
  - MSPM0L
  - MSPM0C

# **Examples applications**with MSPM0C MCUs

**Dennis Lehman** 

MSP Applications Engineer



## Automotive lighting module Using low cost MSPMOC MCUs

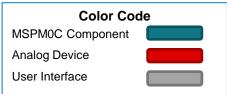
### **System information**

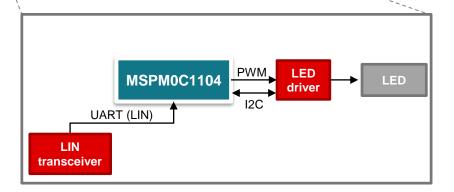
- Reliable communication interface for high-speed and off-board communication
- High-accuracy dimming functionality
- Optimized thermal performance in a small form factor

#### **MSPM0C** features

- **UART** with LIN support
- Integrated ADC
- I2C and SPI communication interfaces
- Small packages







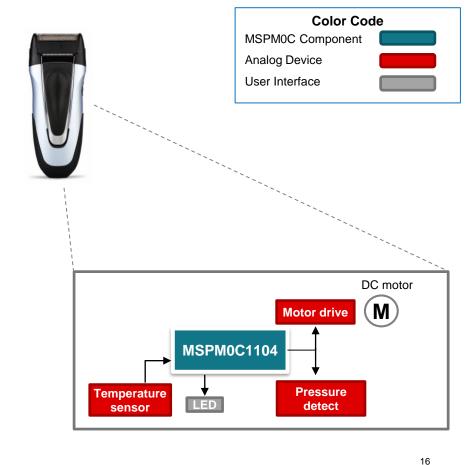
## **Shaver**Using low cost MSPM0C MCUs

#### **System information**

- PWMs needed
- · A few UART needed
- Motor voltage and current measurement
- NTC temperature measurement
- Buttons and LEDs

#### **MSPM0C** features

- 16-bit Advanced timer for dead zone and fault detection
- 3-input Hall sensor mode for position sensing and speed computation
- Up to 10 channel ADC for voltage and current sensing
- DMA controller to boost ADC or other peripheral throughput
- Small packages



## **Automotive window module**

Using low cost MSPM0C MCUs

## **System information**

- Control of powerful mechanism with sensitive anti-pinch detection
- Low-power dissipation while driving high-current loads
- · Minimal conducted and radiated emissions
- Integrity of position information during brief battery supply transients

#### MSPM0C features

- UART with LIN support
- Integrated ADC
- I2C and SPI communication interfaces
- Integrated temperature sensor
- Small packages

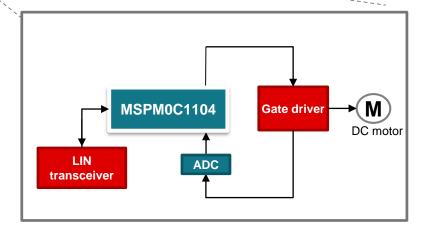


Color Code

MSPM0C Component

Analog Device

User Interface



# **Getting started with MSPM0C MCUs**

Tools & resources *Live demo* 

## **Getting started**

You can start evaluating this device leveraging the following:

Content type	Content title	Link to content or more details
Product information	MSPM0C1104 Product Page	MSPM0C Product Page
Development tool or evaluation kit	MSPM0C1104 LaunchPad™ development kit	LaunchPad development kit
Software	MSPM0 software development kit (SDK)	MSPM0-SDK
Tool Page	Arm® Cortex ®-M0+ MCUs subsystems	MSPM0 Subsystem Tool Page
Technical blog content or white paper	MSPM0Cx- Toothbrush and Shaver	App Brief
Technical blog content or white paper	MSPM0 - Advanced Control Timer Helps for Better Control and Better Digital Output	App Note
Tool Page	Simplified code migration	Tool Page
Webinar Registration	Simplify your software efforts with MSPM0 MCU subsystems	Webinar on Tuesday, June 18 <sup>th</sup> , 2024 Register Now!





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